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The effects of a Cr_{1-x}Ru_x underlayer on the magnetic properties of Co₆₄Cr₂₂Pt₁₄ thin films

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THE EFFECTS OF A $\text{Cr}_{1-x}\text{Ru}_x$ UNDERLAYER ON THE MAGNETIC PROPERTIES OF
 $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ THIN FILMS

A Thesis

Presented to

The Faculty of the Department of Chemical and Materials Engineering
San Jose State University

In Partial Fulfillment

of the Requirements for the Degree

Master of Science

By

Ming-Yuan Liu

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APPROVED FOR THE UNIVERSITY

ABSTRACT

THE EFFECTS OF A $\text{Cr}_{1-x}\text{Ru}_x$ UNDERLAYER ON THE MAGNETIC PROPERTIES OF $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ THIN FILMS

by Ming-Yuan Liu

The magnetic properties of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{1-x}\text{Ru}_x$ thin films sputter deposited on glass substrates used in longitudinal recording were investigated. In-plane coercivity as a function of Ru concentration, $\text{Cr}_{1-x}\text{Ru}_x$ layer thickness, and deposition temperature were studied. The in-plane coercivity increased to 4,100 Oe when a CoCrPt layer was deposited on a 500 Å $\text{Cr}_{43}\text{Ru}_{57}$ underlayer at 250°C. X-ray diffraction showed that the cause of the coercivity increase was the increase of $\text{Co}(10\bar{1}0)$ and $\text{Co}(10\bar{1}1)$ textures and the decrease of $\text{Co}(0002)$ texture. Good lattice matching caused $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ film to grow epitaxially on top of the $\text{Cr}_{1-x}\text{Ru}_x$ film. The preferred c-axis in-plane orientation of $\text{Cr}_{1-x}\text{Ru}_x$ layer controlled the texture of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ layer. The coercivity peak at 57 at.% Ru was very narrow, resulting in a reproducibility problem, which might limit the commercial application of the $\text{Cr}_{1-x}\text{Ru}_x$ underlayer.

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Chapter 1

Introduction

1.1 Background

The recording medium for a disk drive is a film of magnetically hard material on a circular substrate. In the past ten years, the fundamental technology of recording has evolved from particulate to thin film. The introduction of magnetoresistive (MR) heads in 1991 has had further impact on the design of thin film media. This has caused the areal density to increase rapidly. 10 Gb/in² areal density is expected to be achieved by 2010 [1-3]. In order to reach the high areal density, certain magnetic properties are desired [4]. Because the magnetic properties of a recording media can be controlled by the underlayer of a disk, exploring a new material for underlayer is one way to reach the high density recording requirements.

1.2 Disk Structure and Manufacture

The function of a disk is to store data by a magnetic field produced from a recording head, which flies only a few tens of nanometers (nm) above the disk surface. The data is recorded as a series of magnetic transitions which are replicated onto the disk from the signal input into the head. The data is then read back by measuring the magnetic field change by a reading head. The recording media discussed in this thesis is longitudinal recording media, which means the magnetization direction of the media lies in the film plane. The cross section of a general longitudinal disk is shown in Figure 1 [4]. The disk structure consists of a substrate, a sublayer, an underlayer, a magnetic layer, a protective layer, and a lubricant layer.

<u>Purpose</u>	<u>Disk cross section</u>	<u>Thickness</u>	<u>Process</u>
Lubrication	Lubricant	10 Å	Dipping
Protection	Protective layer (C)	150 Å	Sputtering
Recording	Magnetic layer (Co-alloy)	300 Å	Sputtering
Orientation control	Underlayer (Cr)	500 Å	Sputtering
Hardness	Sublayer (Ni-P)	10 µm	Electroless plating
	Substrate (Al-Mg or glass)	0.635 mm	

Figure 1. Typical disk structure and manufacture.

The base structure of the substrate is Al-Mg alloy that is fabricated to different dimensions depending on the drive size. Nowadays, 3.5-inch diameter and 2.5-inch diameter are the most common size. Glass has also been used as a disk substrate material because of its stiffness and hardness.

The second layer of Ni-P, with a thickness of 10 µm, is electroless plated onto the aluminum substrate surface [5]. The purpose of the Ni-P layer is to cover up the defects of the aluminum substrate, and to provide a hard layer which can be polished to a mirror-like surface. The polished surface is then textured to add roughness [6,7]. The texture has three purposes: (1) to reduce the stiction force, (2) to stabilize the head when it is flying over the disk and, (3) to provide an orientation direction for sputtered films in order to introduce magnetic anisotropy on the disk and to make uniform magnetic read-back signals.

An underlayer of Cr of thickness 200-1,000 Å is then sputtered onto the textured disk. The purpose of the Cr layer is to ensure the nucleation of the magnetic film with the easy axis of magnetization in-plane [8]. The Cr underlayer also controls the grain structure of the magnetic layer, which is critical in determining the media noise.

A magnetic layer, with about 300 Å thickness, is then sputtered onto the Cr layer. Ferromagnetic materials are needed for the magnetic layer. Co-based alloys are suitable for this layer because of their large magnetic anisotropy and high coercivity [1,4].

Amorphous carbon is then sputtered for protection. This protective layer is typically 100-150 Å. Finally, a lubricant of thickness 10-30 Å is applied onto the surface of the disk by dipping and draining. The lubricant reduces the friction and wear between the disk and the head.

1.3 Fundamental Magnetic Media Measurements

The vibrating sample magnetometer (VSM) is the most often used instrument for measuring the magnetic properties of recording media. Figure 2 shows a diagram of a typical VSM. The time rate of change of magnetic flux in the pick-up coils is produced by vibrating the magnetized sample. The magnetizing field in a VSM is provided by an electromagnet; typical maximum field is over 10,000 Oe. The sample is attached on a nonmagnetic rod, which vibrates vertically with an amplitude of about 1/16 inch and a frequency of about 60 Hz. When the sample vibrates, the pick-up coils will produce an electrical polarity. The ac voltage is proportional to the sample's magnetic moment. Then this signal along with the applied field signal are connected to an x-y plotter to generate a hysteresis loop.

Figure 2. Diagram of vibrating sample magnetometer [4].

Figure 3 is a hysteresis loop of a thin film disk taken with a VSM. The horizontal axis is the magnetic field (H); the vertical axis is the magnetization (M). Several characteristics can be determined from the hysteresis loop. The maximum magnetization is called the saturation magnetization M_s . The magnetization remaining when the field H is reduced to zero is called the remanent magnetization M_r . The field required to reduce the magnetization to zero is called the coercive force or coercivity H_c . The squareness S and coercivity squareness S^* are determined geometrically by the hysteresis curve. S equals M_r/M_s and S^* equals b/a , see Figure 3 for the definitions of a and b . Both S and S^* vary from 0 to 1. $S = 0$ indicates $M_r = 0$; $S = 1$ indicates $M_r = M_s$. $S^* = 0$ indicates the hysteresis curve would be a straight line from $H = -H_c$ to $M = M_r$; $S^* = 1$ indicates the slope of the hysteresis curve at $H = -H_c$ is infinity.

Figure 3. VSM output – hysteresis loop.

1.4 Magnetic Anisotropy

Ferromagnetic materials exhibit magnetic anisotropy, which means that the magnetic properties are different along different crystal directions. The direction which needs the least magnetic field to saturate the crystal is called the easy axis. The direction which needs the greatest magnetic field to saturate the crystal is called the hard axis. The magnetization along the easy axis needs the least energy, whereas the magnetization along the hard axis consumes the greatest amount of energy.

Figure 4 shows two hysteresis loops. One loop is along the easy axis, and the other is along the hard axis. The hysteresis loop along easy axis looks more square and has greater H_c than the hysteresis loop along hard axis. The magnetic anisotropy is an important property to produce a high H_c recording media.

Figure 4. Hysteresis loops along magnetic easy axis and hard axis.

1.5 High Areal Density Media Requirements

The general design criterion for high density media is to increase the coercivity H_c as much as possible without exceeding the writability of the head, keep coercivity squareness S^* high for sharp transition, and keep magnetic film thickness δ low for high-frequency output and to preclude magnetoresistive (MR) head saturation. Remanence M_r must be adjusted to give adequate signal output without sacrificing resolution.

The values of H_c in use today are around 2,800 Oe. S^* values are typically larger than 0.8, but S^* values above 0.9 may not be desirable since they often indicate high media noise.

The signal-to-noise ratio is another parameter determining the performance of a disk drive. With the use of MR head, media noise become the major noise contributor in the disk drive. The origin of noise in a disk is the nonuniformity in the magnetic domain boundary [9]. There are three major approaches to reduce media noise: physical grain separation [10,11], compositional segregation [12,13], and multilayers [14].

The magnetic properties of a disk are determined by the film microstructure of both magnetic layer and underlayer. The magnetic properties can be improved by using new materials or new processes in the both layers.

1.6 Thesis Objective

This thesis investigated $\text{Cr}_{1-x}\text{Ru}_x$ as an underlayer material for longitudinal recording media. There were two objectives of this project. The first objective was to analyze the magnetic properties of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{1-x}\text{Ru}_x$ and determine whether $\text{Cr}_{1-x}\text{Ru}_x$ is a suitable material for underlayer. The second objective was to understand the relationship between sputtering parameters and magnetic properties for the $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{1-x}\text{Ru}_x$ thin film system.

Chapter 2 of this thesis describes the previous published work relevant to this project. Chapter 3 describes the experimental procedures. Chapter 4 shows the results of the experiment. Chapter 5 discusses the structure and magnetic properties of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{1-x}\text{Ru}_x$ thin films. Chapter 6 gives a conclusion of this thesis and some suggestions for future study.

Chapter 2

Literature Review

The literature review focused on two areas. The first area was articles evaluating new underlayer material for longitudinal recording. All of the closely related articles in this area were published after 1990. The second area of interest was the articles describing the relationship between microstructure and magnetic properties of recording thin films. The articles in this area offer a more basic understanding of thin films.

Many different underlayer materials for longitudinal media have been studied, such as Cr [15,16], Mo [15], W [15,17], Ti [18], NiP [16], NiAl [19-21], MgO [22], and Cr-X binary alloys (X = V, Ti, Mo...) [23-26]. Only a few of them, however, actually perform well. Among them, Cr, Cr-V, Cr-Ti, NiAl and Cr-Mo have received the most intensive investigation.

The performance of a recording media is determined by both the magnetic layer and the underlayer. The magnetic properties of a disk are correlated to the film microstructure and the sputtering processes. Table I summarizes the possible parameters. The process parameters can change the film microstructure, and hence change the magnetic properties. The film microstructure is a way to understand the relationship between the process parameters and film properties.

A general discussion of microstructure effects on the magnetic property of a disk will be made, in Sections 2.1 to 2.4. Section 2.5 reviews the six most important underlayer materials that have been studied. They are Cr, Cr-V, NiAl, Cr/Al, Cr-Ti, and Ru. Section 2.6 gives a summary of the literature review.

Processes (of underlayer and magnetic layer)	Microstructure (of underlayer and magnetic layer)	Properties (of media)
composition	crystallographic texture	coercivity H_C
thickness	grain size	squareness S
substrate temperature	magnetic isolation	coercivity squareness S^*
bias	stacking faults	media noise
sputtering power (rate)		
argon pressure		

Table I. Parameters of a recording media.

2.1 Crystallographic Texture

By controlling the crystallographic texture of the underlayer, the texture of the magnetic film can be changed which in turn changes the magnetic properties of the Co-based film [27, 40]. For longitudinal recording it is necessary to have most of the magnetic grains with their easy axes of magnetization in or near the plane of the film. Co-based alloys, which are hexagonal close-packed, have their c-axis as the easy axis. For Co-based films with their $(10\bar{1}0)$ or $(11\bar{2}0)$ planes parallel to the plane of the film, the c-axes will be in the film plane. If the $(10\bar{1}1)$ planes are in the film plane, the c-axis will be about 28° out of the film plane. Using Cr (BCC) underlayer is a way to produce such HCP films.

2.2 Grain Size

It has been found that as the thickness of the Cr films increases, the grain size also increases [28]. If the Cr underlayer thickness is varied at 260°C while keeping the CoCrTa thickness constant, it was found that the increase in H_C at 260°C was less than 10% when

Cr thickness was increased from 150 to 3000 Å [29]. This indicates that H_c of the CoCrTa films is not strongly influenced by the Cr underlayer grain size.

It is worth pointing out that the grain size of the Co film is often not well defined because the grains have low angle grain boundaries and form clusters with closely related crystallographic orientation. The size of these clusters plays an important role in determining the magnetic properties of the films because magnetic coupling among the grains in the cluster should be strong. It is believed that the cluster size plays a more important role than does the grain size in determining the magnetic properties of CoCrTa/Cr media [30].

2.3 Magnetic Isolation

It has been generally accepted that reduction in the intergranular exchange coupling is critical to obtain low noise magnetic thin film recording media [31,32]. Yogi *et al.* [28] used high sputtering Ar pressures to generate physical separation of grains which apparently leads to the reduced intergranular interaction. Isolation of magnetic grains has also been reported by Yamashita and Chen [33] by controlling the nucleation and growth of the underlayer NiP film in the CoNiPt/NiP system. In sputtered CoCrTa/Cr recording media the low noise and high coercivity have been attributed to the segregation of the nonmagnetic constituents to the grain boundaries [34].

Using nuclear magnetic resonance (NMR) spectroscopy to investigate the local composition around the Co nuclei in the CoCrTa/Cr films, Maeda *et al.* [35] found that the NMR spectra varied systematically with the substrate temperature. In the CoCrTa system, Cheong *et al.* [36] have observed Ta rich precipitates (Co_3Ta , $L1_2$) in the HCP CoCrTa matrix, after heat-treatment at 500°C.

2.4 Stacking Faults

The stacking fault density and the degree of crystalline perfection between the faults is most important in increasing the coercivity and improving signal-noise properties. High substrate temperatures and high Cr and Ta concentrations promote the occurrence of the stacking faults in the films [30]. These faults provide possible sites for elemental segregation which is partially responsible for reducing the magnetic coupling among the unfaulted HCP regions in the CoCrTa films.

Fringe contrast within the grains has often been observed in Co based longitudinal recording media. Hono *et al.* [37] demonstrated that the fringe contrast is due to (0002) stacking faults, which appear to be the dominant structural defects in Co-based alloy film. In the CoCr system, Cr additions were found to increase the fault density [38]. The faults and grain boundaries in CoCr bulk alloys have been reported to act as pinning sites which impede domain wall motion [38].

The impact of a high density of stacking faults can be considered in two ways. First, these faults could provide sites for solute segregation which could reduce exchange coupling between the HCP regions separated by the stacking faults. Elemental segregation at stacking faults has been commonly known as the Suzuki effect [39]. Second, the elastic strain in the films would be minimized due to the formation of the high density of stacking faults. If the strain had built up, the magnetocrystalline anisotropy may have decreased thereby lowering the H_C and noise properties of the films.

The lower Co concentration films ($\text{Co}_{82.8}\text{Cr}_{14.6}\text{Ta}_{2.6}/\text{Cr}$) had much higher H_C than the Co richer films for a given substrate temperature, even though they had a lower M_S . Fewer stacking faults were observed in the Co rich films ($\text{Co}_{86}\text{Cr}_{12}\text{Ta}_2/\text{Cr}$) [30]. This also suggests that the higher H_C of the film with less Co is probably due to a higher density of the faults and therefore possibly more segregation for a given substrate temperature.

2.5 Characteristics of Specific Underlayer Materials

2.5.1 Cr Underlayer

Laughlin *et al.* [40] discussed various ways that the crystallographic texture of a thin film can be controlled. The control of other microstructural aspects such as grain size and crystalline perfection by means of underlayers was also included.

In order to produce a thin film of a Co based alloy (HCP) with its c-axis in or near the plane of the film, an underlayer must be used. This is because all crystalline materials have preferred growth directions when produced as thin films. The planes parallel to the film usually will be the closest packed ones. Therefore, an HCP phase will usually grow with its c-axis perpendicular to the film plane, unless it is forced to do otherwise during the initiation of its formation on the substrate.

Cr thin films (BCC) deposited at room temperature tend to develop the $\{110\}$ in-plane crystallographic texture. Cr underlayers with this crystallographic texture will produce Co-alloy thin films with their c-axis out-of-plane. However, by controlling the processing variables, Cr films with a $\{200\}$ in plane crystallographic texture can be produced. This texture will produce Co-alloy thin films with their $\{11\bar{2}0\}$ parallel to the film plane, i.e., c-axis in-plane. This change in crystallographic texture has been explained in terms of a model which emphasizes the role of surface energies during the nucleation stage of the Cr thin films [41]. This model assumes that the closest packed $\{110\}$ planes of Cr have lower surface energies than the $\{200\}$ planes. Thus, when the nuclei of Cr first form, they will tend to maximize the amount of $\{110\}$ surface area.

For epitaxy to arise between a magnetic film and its underlayer, one or two directions in the magnetic film must have good atomic matching with directions of the underlayer. When this occurs, specific planes of atoms in the film orient themselves with respect to specific underlayer planes. Thus, if the underlayer has a crystallographic texture, the magnetic film will start off with a crystallographic texture that is controlled by the

$(10\bar{1}1)$ Co	$\parallel$	(110) Cr
$(11\bar{2}0)$ Co	$\parallel$	(002) Cr
$(10\bar{1}0)$ Co	$\parallel$	(112) Cr
$(10\bar{1}0)$ Co	$\parallel$	(113) Cr
$(11\bar{2}1)$ Co	$\parallel$	(111) Cr

Table II. Crystallographic Relations of Co grain with their Cr underlayer [40].

crystallographic texture of the underlayer. Table II summarizes some of the observed crystallographic relationships between Co-alloy films and their Cr underlayers. Each of these crystallographic relationships can be understood in terms of epitaxy.

Figure 5 is a schematic of a single grain of Cr with its (002) plane parallel to the film. It is possible for the Co alloy that is deposited on top of Cr to form two distinct orientations of grains. Since the (002) plane of Cr has four-fold symmetry, the (0002) planes of the Co alloy may form parallel to either of the mutually perpendicular (110) and $(1\bar{1}0)$ Cr planes. This degeneracy will occur if the rate of formation of the Co nuclei is fast enough to form several nuclei before the lateral growth covers the Cr grain. Faster sputtering rates favor this situation. Thus for every grain of Cr, there may be several grains of the Co film .

Figure 5. Two variants of a Co alloy form on a single Cr grain [40].

Another microstructural feature that can be controlled is the perfection of the grain. A film formed with an applied bias shows a higher degree of crystal perfection than without bias. Finally, the use of underlayers affect the properties of the Co alloy films by means of inter-diffusion. The Cr atoms diffuse into the magnetic Co films along the grain boundaries. This not only changes the composition of the magnetic films, but also increases the magnetic grain isolation, causing changes in coercivity and coercivity squareness.

2.5.2 Cr-V Underlayer

Parker *et al.* [23] investigated the influence of a CrV underlayer on the microstructure, crystallography, and epitaxy of CoCrPt, and the effects on the coercivity. The samples consisted of 350 Å $\text{Co}_{75}\text{Cr}_{13}\text{Pt}_{12}$ magnetic layer deposited on 500 Å underlayers of Cr-V with the following compositions in at.% V: pure Cr, 10%, 20%, 50%, 80%, and pure V.

Figure 6. H_c and misfit as a function of Cr-V composition [23].

Figure 6 shows the variation of coercivity H_C in the CoCrPt films as a function of the composition of the Cr-V underlayer. The calculated misfits between the (0001) Co and (110) Cr interplanar spacing are given on the right axis of the plot; minimal misfit occurs at approximately 50% V. This is also the composition with the highest coercivity. The plot suggests that improving the lattice match between the underlayer and the magnetic layer improves H_C . The lattice parameters of CoCrPt and Cr-V were determined by X-ray diffraction analysis. By analyzing the intensity of the peaks, the texture of the films can also be determined, as shown in Figure 7.

The coercivity increased between 20 and 50% V content because of the increasing fraction of (11 $\bar{2}$ 0) Co grains with c-axis in plane; c-axis of Co alloy is the magnetic easy axis. The increasing c-axis in-plane is because of the improving degree of epitaxy between the CoCrPt and the Cr-V underlayer.

Figure 7. X-ray diffraction analysis of CoCrPt/Cr-V [23].

The authors report significant effort in transmission electron microscopy (TEM) and X-ray analysis. They also showed that the S^* was increased by using a Cr-V underlayer. But the authors did not provide other magnetic properties, such as S and media noise, in order to evaluate whether Cr-V is a suitable material for the underlayer.

2.5.3 NiAl Underlayer

Lee *et al.* [19] investigated $\text{Co}_{86}\text{Cr}_{12}\text{Ta}_2$ magnetic films which were sputter-deposited on NiAl underlayers on glass substrates. The magnetic layer, CoCrTa, was maintained at a constant thickness of 40 nm for all samples. The relationship between in-plane coercivity and underlayer thickness was investigated. Substrate bias during deposition of NiAl underlayer was also studied.

The NiAl film was found to have the B2 structure with a lattice parameter of 0.2884 nm. NiAl has an almost identical lattice parameter as Cr, 0.2887 nm. Schematics of the crystal structures of NiAl and Cr are shown in Figure 8. The grain size of a 100 nm NiAl film is about 15 nm, which is about 50% smaller than the grain size of a Cr film. A uniform, fine grain underlayer is beneficial because it will give rise to a Co magnetic layer with smaller grain size, which would yield better signal-to-noise ratios in their recording performance.

Figure 8. Crystal structures of the Cr (BCC) and NiAl (B2) [19].

Figure 9. Coercivity vs. underlayer thickness without substrate bias [19].

Figure 9 shows the coercivity value of magnetic layers on various thickness of NiAl or Cr underlayers without substrate bias or heating. In both cases, the coercivity increased as the underlayer thickness increased. Figure 10 is similar to Figure 9 except the CoCrTa layer was deposited at a -200 V substrate bias. The substrate bias increases coercivity in both CoCrTa/Cr and CoCrTa/NiAl films. But the coercivity increase in CoCrTa/NiAl films is higher.

Figure 10. Coercivity vs. underlayer thickness with a -200 V substrate bias during Co alloy deposition [19].

The substrate bias during the Cr sputtering process alone can increase the coercivity of the CoCrTa/Cr film by about 60%. However, the substrate bias during NiAl sputtering decreased the coercivity of the CoCrTa/NiAl film, Figure 11. The energy dispersive X-ray spectroscopy analysis showed that the bias sputtering changed the composition of the NiAl film. An increase of substrate bias voltage from 0 to -200 V can change the Al content from 52.3 at.% to 42 at.%. This is due to the preferential resputtering of the Al during the deposition. With the -200V substrate bias, the NiAl underlayer showed a mixture of B2 NiAl and the orthorhombic Ni_5Al_3 phases. Therefore, As the bias voltage increased, the CoCrTa film gradually lost its epitaxially growth of c-axis in-plane texture, and as a result its coercivity decreased.

Figure 11. Coercivity vs. substrate bias during the NiAl's deposition [19].

2.5.4 Cr/Al Underlayer

The effect of Cr/Al underlayers on the magnetic properties of $\text{Co}_{77}\text{Cr}_{11}\text{Pt}_{10}\text{Ta}_2$ films deposited on glass substrates were investigated by Chang *et al.* [43]. The effects of an Al overlayer on the magnetic properties of CoCrPtTa/Cr films were also studied.

The magnetic properties of the thin films are shown in Table III. The coercivity increased and the coercivity squareness decreased by using Al over-coated and Al under-coated films, compared to Cr only.

The coercivity increase is attributed to the increase of c-axis in-plane texture, the increase of magnetic isolation of CoCrPtTa grains, and the refinement of CoCrPtTa grains deposited on Cr/Al underlayers. The decrease of coercivity squareness is attributed to the magnetic isolation of CoCrPtTa grains. The increase of c-axis in-plane texture is due to the lattice expansion of a Cr layer deposited on an Al layer. The increase of magnetic isolation is due to Al atoms diffused into the grain boundaries of CoCrPtTa rather than inside CoCrPtTa grains.

Thin films	H _c (Oe)	S*
CoCrPtTa/Cr	1350	0.89
CoCrPtTa/Cr/Al	1740	0.87
Al/CoCrPtTa/Cr	1475	0.84

Table III. Magnetic properties of Al underlayer and Al overlayer thin films [43].

2.5.5 Cr-Ti Underlayer

The effects of Ti addition to a Cr underlayer on the magnetic and crystallographic properties of CoCr₂₀Pt (Pt: 8 and 12 at. %) media were investigated by Matsuda *et al.* [24].

In-plane coercivity and coercivity squareness increased as Ti was added up to 25% to the Cr underlayer, as shown in Figure 12. The media noise decreased with an increase of the Ti content from 0 to 20 at. %. Transmission electron microscopy studies showed that the average grain size of Cr-Ti films decreased from 30 to 20 nm with the Ti content increasing from 0 to 20 at. %, as shown in Figure 13.

Figure 12. H_c and S^* as a function of Ti content [24].

Figure 13. Grain size of Cr-Ti as a function of Ti content [24].

The increase of H_C and S^* is due to the lattice matching between CoCrPt and Cr-Ti films by expanding the Cr lattice with the addition of Ti. The reduction of media noise is due to the decrease of magnetic grain size which is caused by the decrease of Cr-Ti underlayer grain size. The decrease of magnetic grain size seems to be correlated with the nucleation density of the Cr-Ti film. From the structure analyses, it seemed that the increase of noise at the high Ti content was caused by the increase and a wider distribution of Cr-Ti grain size.

This paper provided Cr-Ti as a good candidate for the underlayer. Ti addition to Cr underlayers is advantageous to improve the recording properties since the media noise is remarkably reduced without a decrease of H_C and S^* . Although this paper showed successful results, it did not explain clearly how the lattice matching related to the increase of H_C and S^* , and how the grain size related to the media noise. Further studies from other papers are necessary to understand these effects.

2.5.6 Ru Underlayer

Ru underlayer has been studied by Lee [44]. Ru underlayer can induce high H_C . In some cases, the H_C can reach more than 5,000 Oe. X-ray diffraction showed that the samples with high H_C have strong Co c-axis in-plane texture. Both Ru and Co alloy have the same crystal structure (HCP), and they have similar lattice parameters.

Ru and most Ru compounds are toxic [45]. Ru is retained in the bones for a long time. When heated to decomposition it emits very toxic fumes of RuO_x and Ru which are highly injurious to the eyes and lung and can produce nasal ulcerations. The environmental problem may prevent Ru from being used in some applications.

2.6 Summary of Literature Review

Table IV summarizes different underlayer materials that have been studied. The crystal structures and the maximum H_C are included. The underlayer materials in the literature review are all cubic structures except Ru, which is HCP. The magnitude of H_C is strongly dependent on the deposition parameters and the type of the magnetic films. The H_C in Table IV are the largest possible values found in the literature review.

From the literature review, it is believed that the Cr binary alloys are strong underlayer candidates for high density longitudinal recording. The Cr lattice matches with Co alloys in certain planes and certain directions. This lattice matching can induce Co c-axis in-plane texture that is desired for high density recording. The lattice matching can be further fine tuned by alloying Cr with other elements.

Ru is also a strong candidate material for underlayer. It is possible that if Cr is alloyed with Ru, $Cr_{1-x}Ru_x$ thin film will induce the required microstructure of Co layer and get the required magnetic property. For this reason, $Cr_{1-x}Ru_x$ underlayer is chosen for this thesis. One drawback to use Ru is that Ru is toxic. Nevertheless it is still worthy to study the microstructure-properties relationship from the $Co_{64}Cr_{22}Pt_{14}/Cr_{1-x}Ru_x$ thin films.

Underlayer Material	Structures	Coercivity (H_C)
No underlayer	-----	~500
Cr	BCC	~1,500
NiAl	B2	~1,700
Cr-V	BCC	~1,700
Cr-Mo	BCC	~2,500
Cr-Ti	BCC	~3,800
Cr/Al	BCC/FCC	~1,740
Cr/NiAl	BCC/B2	~3,000
NiAl/MgO	B2/B1	~3,400
Ru	HCP	~5,000

Table IV. Summary of different underlayer materials

Chapter 3

Experimental Procedures

3.1 Experiment Outline

This experiment used $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ magnetic layer deposited on top of $\text{Cr}_{1-x}\text{Ru}_x$ underlayer by sputtering. The experiment investigated the effects of $\text{Cr}_{1-x}\text{Ru}_x$ underlayer on the magnetic properties of the $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{1-x}\text{Ru}_x$ thin films at different Ru concentration, $\text{Cr}_{1-x}\text{Ru}_x$ layer thickness, and substrate temperatures. The process parameters of the $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ layer, such as composition, thickness, and deposition rate, were fixed throughout the experiment.

The experiment was comprised of two phases. Phase I was $\text{Cr}_{1-x}\text{Ru}_x$ composition dependence study. Phase II was $\text{Cr}_{1-x}\text{Ru}_x$ thickness and substrate temperature dependence study. In Phase I, the composition of $\text{Cr}_{1-x}\text{Ru}_x$ was changed from 0% Ru to 100% Ru. The thickness of $\text{Cr}_{1-x}\text{Ru}_x$ layer was fixed at 500 Å, and the substrate temperature was fixed at 250°C. At 57 at.% Ru, the in-plane H_C was highest, about 4,100 Oe. The $\text{Cr}_{1-x}\text{Ru}_x$ film of 57% Ru was used as a fixed composition in Phase II because the samples at this composition have highest H_C . The effects of underlayer thickness and deposition temperature on the magnetic properties were studied in Phase II.

In order to analyze the magnetic properties of the samples, coercivity H_C , coercivity squareness S^* , and squareness S were measured by VSM. The crystallographic texture was determined by X-ray diffraction. Film thickness, composition, and resistivity were also measured in the experiment.

The following sections explain the details of the experiment procedures. Section 3.2 shows the procedures by which the samples were made. Section 3.3 through Section 3.5 explain the procedures of measuring the properties of the samples.

3.2 Sample Preparation

This experiment used 1-inch-diameter glass substrates on which the films were deposited. The substrates were cleaned by acid etch before depositing films. A DC magnetron sputtering system was used to make the films. The sputtering system used in this experiment was made by Sputter Thin Film Inc. Substrate bias was not able to be controlled in this system. All other sputter parameters such as sputtering power, argon pressure, and substrate temperature were controlled and monitored directly by this system. Six samples were made per pumpdown. These six samples might have different thickness and different composition by controlling the sputtering rate and time, but different substrate temperature in one pumpdown was not practically possible because it took a long time for temperature to be in equilibrium. Six samples of the same substrate temperature were made for each pumpdown in this system. Each pumpdown took overnight to reach high vacuum, about 10^{-7} torr. Before the films were made, the tooling factor had been calibrated in order to read the right thickness directly from the display. The procedures of calibrating the tooling factor are illustrated in Section 3.5.

3.2.1 Phase I -- The Effects of the Ru Concentration on the $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{1-x}\text{Ru}_x$ Magnetic Properties

The first parameter this experiment investigated was the underlayer composition. $\text{Cr}_{1-x}\text{Ru}_x$ thin films were made by co-sputtering from the targets of pure Cr and pure Ru. The composition of Cr and Ru was controlled by the relative deposition rate of Cr and Ru; the Ru concentration was varied from 0% to 100% with a step of about 5% (sample # 1-14 and # 30-42). For this phase, the underlayer thickness was kept at 500 Å, substrate temperature at 250°C, and argon pressure at 6 mTorr. After depositing the underlayer, a magnetic film was sputtered subsequently. As mentioned in Section 3.1, magnetic film deposition parameters were fixed throughout the experiment. The magnetic layer

$\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$	Thickness: 250Å
$\text{Cr}_{1-x}\text{Ru}_x$	Thickness: 500Å
Glass substrate	Substrate temperature: 250°C

Figure 14. Profile of the sample for Phase I.

composition was $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$, and the thickness was kept at 250 Å. The magnetic layer was deposited by sputtering the right composition target. The profile of the sample is shown in Figure 14. After the films were made, the magnetic properties of the $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{1-x}\text{Ru}_x$ thin films were measured by VSM. The details about VSM are described in the next section.

When the VSM measurement was finished, the Ru concentration was narrowed down to 1 at.% step around the specific composition of interest (sample # 15-19 and # 26-29). The composition with maximum H_C was determined by the previous step. The composition of 57 at.% Ru had maximum H_C and was most interesting. Another six 57% Ru samples were made during different pumpdowns to investigate uniformity (sample # 20-25). All the parameters and procedures were the same as in the previous deposition. The relationship between the H_C and the Ru composition was then determined. The samples made in Phase I are summarized in Table V.

The composition of $\text{Cr}_{1-x}\text{Ru}_x$ film was controlled roughly by calculating the relative deposition rate of Cr and Ru. More accurate composition was determined by Rutherford Backscattering Spectrometry (RBS). In addition to the samples with both $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ layer and $\text{Cr}_{1-x}\text{Ru}_x$ layer, the samples with $\text{Cr}_{1-x}\text{Ru}_x$ layer only were also made. RBS, X-ray diffraction, and resistivity measurements of $\text{Cr}_{1-x}\text{Ru}_x$ layer were made without the interference of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ layer. The samples with $\text{Cr}_{1-x}\text{Ru}_x$ layer only are also shown in Table V.

Co ₆₄ Cr ₂₂ Pt ₁₄ /Cr ₁ Ru/glass		Cr ₁ Ru/glass	
Sample	Ru at. %	Sample #	Ru at. %
1	0.3	43	0.3
2	6.2		
3	12.5	44	12.5
4	18.7		
5	21.2		
6	24.0	45	24.0
7	25.1		
8	27.3		
9	29.5		
10	30.6		
11	37.3	46	37.3
12	43.4		
13	47.5	47	47.5
14	53.3	48	53.3
15	54.2		
16	55.1	49	55.1
17	56.1		
18	56.1		
19	57.0	50	57.0
20	57.0	51	57.0
21	57.0		
22	57.0		
23	57.0		
24	57.0		
25	57.0		
26	58.2		
27	58.2		
28	59.4	52	59.4
29	61.2		
30	63.9		
31	68.4		
32	72.9	53	72.9
33	77.4		
34	79.2		
35	81.0	54	81.0
36	84.1		
37	85.6		
38	86.4		
39	88.7		
40	91.7		
41	95.6		
42	99.7	55	99.7

Table V. Experiment samples of Phase I.

3.2.2 Phase II -- The Effects of the $\text{Cr}_{1-x}\text{Ru}_x$ Thickness and the Substrate Temperature on the $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{1-x}\text{Ru}_x$ Magnetic Properties

The samples with 57 at.% Ru had highest H_C by the results of Phase I. In Phase II, the $\text{Cr}_{1-x}\text{Ru}_x$ composition was fixed at 57 at.% Ru, and changed six different underlayer thickness and four different substrate temperatures during underlayer deposition to see the magnetic property response. All the other parameters were fixed. The samples were made with underlayer thickness at 50, 100, 250, 500, 1000, and 2000 Å, and substrate temperatures at 25°C, 100°C, 250°C and 350°C. The magnetic layer composition was $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$, and the thickness was kept at 250 Å. The profile of the sample is shown in Figure 16. After the magnetic properties were measured by VSM, the effects of the $\text{Cr}_{1-x}\text{Ru}_x$ thickness and the substrate temperature on the $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{1-x}\text{Ru}_x$ magnetic properties was determined.

In order to determine the crystallographic texture, X-ray diffraction was used for this experiment. From the X-ray diffraction data, the relationship between H_C and crystallographic texture was determined. For the same reason in Phase I, the samples with $\text{Cr}_{1-x}\text{Ru}_x$ layer only were made in order to get the measurements feasible and accurate for RBS, X-ray diffraction, and resistivity. The samples of Phase II are summarized in Table VI.

$\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$	Thickness: 250Å
$\text{Cr}_{43}\text{Ru}_{57}$	Thickness: 50, 100, 250, 500, 1000, 2000Å
Glass substrate	Substrate temperature: 25, 100, 250, 350°C

Figure 15. Profile of the sample for Phase II.

$\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{1-x}\text{Ru}_x/\text{glass}$			$\text{Cr}_{1-x}\text{Ru}_x/\text{glass}$		
Sample	Deposition Temperature	$\text{Cr}_{1-x}\text{Ru}_x$ Thickness	Sample #	Deposition Temperature	$\text{Cr}_{1-x}\text{Ru}_x$ Thickness
56	25°C	50 Å	77	25°C	50 Å
57	25°C	100 Å	78	25°C	100 Å
58	25°C	250 Å	79	25°C	250 Å
59	25°C	500 Å	80	25°C	500 Å
60	25°C	1000 Å	81	25°C	1000 Å
61	25°C	2000 Å	82	25°C	2000 Å
62	100°C	50 Å	83	100°C	50 Å
63	100°C	100 Å	84	100°C	100 Å
64	100°C	250 Å	85	100°C	250 Å
65	100°C	500 Å	86	100°C	500 Å
66	100°C	1000 Å	87	100°C	1000 Å
67	100°C	2000 Å	88	100°C	2000 Å
68	250°C	50 Å	89	250°C	50 Å
69	250°C	100 Å	90	250°C	100 Å
70	250°C	250 Å	91	250°C	250 Å
71	250°C	500 Å	92	250°C	500 Å
72	250°C	1000 Å	93	250°C	1000 Å
73	250°C	2000 Å	94	250°C	2000 Å
74	350°C	250 Å	95	350°C	250 Å
75	350°C	500 Å	96	350°C	500 Å
76	350°C	1000 Å	97	350°C	1000 Å

Table VI. Experiment samples of Phase II.

3.3 Magnetic Properties Measurement

The magnetic properties of the samples were determined by a VSM. The samples were loaded into the VSM such that the film plane was parallel to the external magnetic field. The magnetic properties were measured parallel to the film plane. The in-plane H_C , in-plane S^* , and other in-plane magnetic properties were used throughout this experiment. The terms without specifying “in-plane” are used in the rest of the thesis.

The VSM was controlled by a computer. For $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{1-x}\text{Ru}_x$ thin films, a maximum magnetic field of 17,000 Oe was used to saturate the samples. The magnetic field was decreased gradually and reached -17,000 Oe. Then it was increased to 17,000 Oe again. During the cycle, the magnetic moment was measured by a “pick-up” coil and

recorded by the computer. The recorded data were processed to eliminate the interference of the glass substrate. After the data were processed by the computer, a hysteresis loop was plotted and the H_c , S^* , and other magnetic data were determined. A sample VSM output is shown in Figure 16.

Figure 16. VSM output (sample #4).

3.4 X-ray Diffraction Measurement

The crystal structure, lattice parameter, and texture of a sample were determined by X-ray diffraction. The X-ray diffractometer used for this experiment was made by Siemens, Model D-5000 which was fully computerized. The X-ray diffraction parameters were controlled by a computer. The data analysis such as the interplanar spacing (d) were also calculated by the computer. The diffractometer used $\text{Cu K}\alpha_1$ radiation with a wavelength of $1.5409 \text{ \AA}$. The Cu-target X-ray tube operated at 50 kV and 300 mA. The samples were scanned from $2\theta = 35^\circ$ to 85° with a step of 0.05° . The samples were exposed to the X-radiation four seconds per step. It took about one hour for each sample to be scanned. The samples of both Phase I and Phase II were measured with the X-ray diffraction after the VSM measurement.

3.4.1 Crystal Structure and Lattice Parameter Determination

Figure 17 shows a X-ray diffraction plot. The d values of the reflection planes, in $\text{\AA}$, are shown on top of each indexed peak. The d value of a characteristic peak was compared with Joint Committee on Powder Diffraction Standards (JCPDS) diffraction data cards of Co, Cr, Ru, and Cr_7Ru . The corresponding structure and reflection plane of an individual peak was identified by matching the d value with JCPDS data. The structures and reflection planes are also shown in Figure 17. This plot shows that the $\text{Cr}_{43}\text{Ru}_{57}$ layer has a Ru structure, and the $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ layer has a Co structure.

The lattice parameter was calculated from the d value. For example, the d value equals $2.132 \text{ \AA}$ for the Ru(0002) plane. Because lattice parameter c is twice the interplanar spacing of (0002), the lattice parameter c for $\text{Cr}_{43}\text{Ru}_{57}$ equals $4.264 \text{ \AA}$. The lattice parameter a was determined in a similar way.

Figure 17. X-ray diffraction output (sample #23, $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{43}\text{Ru}_{57}$)

3.4.2 Lattice Misfit Determination

The difference between the interatomic distance on the matching planes along the matching directions is called the lattice misfit. Lattice misfit (δ) was calculated by the following equation,

$$\delta = \left| \frac{d_1 - d_2}{d_1} \right|$$

where d represents the interatomic distance. Using Figure 17 as an example, the interatomic distances of Ru and Co on the {0002} plane along the $\langle 0001 \rangle$ direction are 2.132 Å and 2.094 Å, respectively. Therefore,

$$\delta = \left| \frac{2.132 - 2.094}{2.132} \right| = 1.78\%$$

3.4.3 Crystallographic Texture Determination

The relative intensity of individual peaks was used to determine the crystallographic texture of the sample. For a powder sample of Ru, the intensity ratio between (10 $\bar{1}$ 0) and (0002) is 1.14, which is determined from JCPDS data. In Figure 17, the intensity ratio between (10 $\bar{1}$ 0) and (0002) is about 0.25, which implies the sample has more Ru(0002) in-plane texture than a randomly oriented sample.

3.5 Film Thickness, Composition and Resistivity Measurement

Before the films were deposited, the sputtering system needed to be calibrated. A film of roughly 500 Å was deposited. An ink spot was marked on the center of a substrate to shield the substrate before a film was deposited. After the ink was wiped off, a step with the film thickness was created. The film thickness was determined by a profilometer. The difference between the measured thickness from the profilometer and the readout thickness from the sputtering system was eliminated by adjusting a proportional constant called the tooling factor. The thickness needed to be measured by the profilometer only in the calibration stage. After the tooling factor was calculated and input into the sputtering system, the film thickness was read directly from the display of the sputtering system.

The composition of Cr_{1-x}Ru_x film was calculated by the relative deposition rate of Cr and Ru. The equations are shown below.

$$n_i(\text{mol}) = \frac{R(\text{cm/s}) * t(\text{s}) * A(\text{cm}^2) * \rho(\text{g/cm}^3)}{AW(\text{g/mol})}$$

$$\text{Ru at\%} = n_{\text{Ru}} / (n_{\text{Ru}} + n_{\text{Cr}})$$

where n_i is the amount of substance i , R is the deposition rate, t is the deposition time, A is the substrate area, ρ is the density, and AW is the atomic weight.

Some samples which needed more accurate composition measurement was determined by Rutherford Backscattering Spectrometry (RBS). The concentration uncertainty by RBS was ± 1 at.%. More information about RBS can be found in other references [46].

The sheet resistance of $\text{Cr}_{1-x}\text{Ru}_x$ layer was determined by a 4-point probe right after the samples were taken out of the sputtering chamber to prevent surface contamination. The sheet resistance was converted to resistivity to exclude the influence of the film thickness by the following equation,

$$\rho(\Omega \cdot m) = R_s(\Omega) * t(m)$$

where ρ is resistivity, R_s is sheet resistance, and t is film thickness. Changes in resistivity between samples could result from the presence of different phases, different grain sizes, defects, or contamination. Resistivity measurement is a simple way to detect microstructure changes.

Chapter 4

Results

4.1 X-ray Diffraction Spectra

The X-ray diffraction spectra of $\text{Cr}_{1-x}\text{Ru}_x$ thin films with different Ru concentrations are shown in Figure 18. By comparing the d values with the JCPDS diffraction data cards, the crystal structures and the reflection planes were identified. The identified structures and the reflection planes are also shown.

From the X-ray diffraction spectra, the structure of $\text{Cr}_{1-x}\text{Ru}_x$ film with Ru concentration below 24% was Cr structure (BCC). At around 37% Ru, the structure changed to Cr_2Ru compound (tetragonal). When Ru concentration increased to 48%, the $\text{Cr}_{1-x}\text{Ru}_x$ film appeared amorphous, or very fine-grained. The $\text{Cr}_{1-x}\text{Ru}_x$ film with a Ru concentration 53% or more has Ru structure (HCP).

One interesting thing found in the X-ray diffraction spectra is that the locations of the peaks shift as the Ru concentration changes. Several lines connecting the same peaks of different Ru concentration are shown in the plot. Those lines are not vertical, which indicates the lattice parameter of $\text{Cr}_{1-x}\text{Ru}_x$ increases as the Ru concentration increases.

The X-ray diffraction spectra of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{1-x}\text{Ru}_x$ thin films are shown in Figure 19. The coercivity of the films are also listed. The difference between Figure 19 and Figure 18 is that the Co diffraction peaks are seen in Figure 19, due to the presence of the $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ layer. The Co peaks shift to low 2θ angle as the Ru concentration increases due to the coherent interface between $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ and $\text{Cr}_{1-x}\text{Ru}_x$ layers. The intensity of the Co peaks and the H_c are closely related. For example, 47.5% Ru sample has low H_c and very strong $\text{Co}(0002)$ intensity, whereas 57% Ru sample has high H_c and a significant $\text{Co}(10\bar{1}0)$ peak. More detail will be discussed below.

Figure 18. X-ray diffraction spectra of $\text{Cr}_{1-x}\text{Ru}_x$ film with different Ru concentration.

Figure 19. X-ray diffraction spectra of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{1-x}\text{Ru}_x$ with different Ru concentration.

4.2 Dependence of $\text{Cr}_{1-x}\text{Ru}_x$ Resistivity on the Ru Concentration

The resistivities of $\text{Cr}_{1-x}\text{Ru}_x$ thin films with different Ru concentration are listed in Table VII. The resistivities were converted from the sheet resistance which was measured by 4-point probe. Figure 20 shows the plot of the resistivity of $\text{Cr}_{1-x}\text{Ru}_x$ vs. Ru concentration. The resistivity in the region between 24% Ru and 53% Ru was higher than the resistivity above or below. The resistivity data might indicate that these $\text{Cr}_{1-x}\text{Ru}_x$ alloys have different crystal structure from the lower resistivity alloys. This prediction was confirmed by the X-ray diffraction spectra. The crystal structures in different Ru concentration regions are shown in the plot.

The resistivities of pure Cr and pure Ru from this experiment are $41.7\text{E-}8\ \Omega\text{m}$ and $16.4\text{E-}8\ \Omega\text{m}$, respectively, as shown in Table VII. These resistivities are higher than the published data [47] for bulk element Cr and Ru, which are $12.6\text{E-}8\ \Omega\text{m}$ for Cr, and $7.1\text{E-}8\ \Omega\text{m}$ for Ru. Thin films have higher resistivity than bulk samples due to two reasons. First, thin films have more disorder structures and smaller grain size. The electrons are more frequently scattered at the grain boundaries and the other crystal defects. Second, as the thickness decreases, the electrons can also be scattered from the surfaces.

Sample #	Ru%	Resistivity (E-8 Ωm)
43	0.3	41.7
44	12.5	71.6
45	24.0	59.3
46	37.3	113.2
47	47.5	118
48	53.3	60.1
49	55.1	54.4
50	57.0	55.7
51	57.0	58.6
52	58.2	56.5
53	72.9	53.1
54	81.0	47.8
55	99.7	16.4

Table VII. Resistivity of $\text{Cr}_{1-x}\text{Ru}_x$ at different Ru concentrations.

Figure 20. The resistivity of $\text{Cr}_{1-x}\text{Ru}_x$ vs. Ru concentration. The circles in 0% and 100% Ru indicate the bulk resistivity of Cr and Ru.

At both BCC and HCP regions, the resistivity increases as the alloy concentration increases. The resistivity of the $\text{Cr}_{1-x}\text{Ru}_x$ solid solution is higher than the resistivity of the pure element because the electrons are more frequently scattered by the impurity atoms. The resistivity of $\text{Cr}_{1-x}\text{Ru}_x$ alloy in the region between 24% Ru and 53% Ru is higher than the resistivity of $\text{Cr}_{1-x}\text{Ru}_x$ with a BCC or HCP structure. In that region, the structure is either amorphous or very fine grained. The disorder structure and the dense grain boundary cause the resistivity to increase.

The Cr-Ru resistivity data can be explained by electron scattering. The resistivity data also perfectly match the structures determined from the X-ray diffraction. The $\text{Cr}_{1-x}\text{Ru}_x$ structure as a function of Ru concentration is further confirmed.

4.3 Textures of $\text{Cr}_{1-x}\text{Ru}_x$ and $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ thin films

The crystallographic relationship between the Cr BCC structure and the Co HCP structure is well known, as discussed in the literature review. Above 53% Ru, $\text{Cr}_{1-x}\text{Ru}_x$ film is HCP structure. Only HCP structure is discussed here.

The crystallographic texture of $\text{Cr}_{1-x}\text{Ru}_x$ film was strongly dependent on the Ru concentration, as shown in Figure 18. At 53.3% Ru, the $\text{Cr}_{1-x}\text{Ru}_x$ film had strong Ru(0002) texture. This texture changed to the mixed Ru($10\bar{1}0$) and Ru($10\bar{1}1$) texture when the Ru concentration increased to 55.1%. When the Ru concentration increased further, the Ru(0002) texture increased gradually again. Figure 21 shows a sketch explaining how the $\text{Cr}_{1-x}\text{Ru}_x$ texture changes as the Ru concentration changes.

Figure 21. Sketch of Cr-Ru texture as a function of Ru concentration. Only HCP structure is discussed. The horizontal arrows indicate the c-axis in-plane component texture. The vertical arrows indicate the c-axis out-of-plane component texture.

There is a direct correlation between $\text{Cr}_{1-x}\text{Ru}_x$ texture and $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ texture. By examining the X-ray diffraction spectra in Figure 19, the samples that have higher $\text{Ru}(0002)$ intensity have also higher $\text{Co}(0002)$ intensity. The samples that have higher $\text{Ru}(10\bar{1}0)$ intensity have also higher $\text{Co}(10\bar{1}0)$ intensity.

Figure 22 shows the X-ray intensity ratio of $\text{Co}(10\bar{1}0)$ and $\text{Co}(0002)$ vs. the X-ray intensity ratio of $\text{Ru}(10\bar{1}0)$ and $\text{Ru}(0002)$. The ratios indicate the degree of c-axis in-plane texture of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ and $\text{Cr}_{1-x}\text{Ru}_x$ films. These two ratios are positively correlated, indicating that the stronger the Ru in-plane texture, the stronger the Co in-plane texture. $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ layer tends to duplicate the texture from $\text{Cr}_{1-x}\text{Ru}_x$ layer because of the epitaxy relationship between these two layers.

Figure 22. X-ray intensity ratio of $\text{Co}(10\bar{1}0)$ and $\text{Co}(0002)$ vs. X-ray intensity ratio of $\text{Ru}(10\bar{1}0)$ and $\text{Ru}(0002)$.

4.4 Dependence of H_C and S^* on $Cr_{1-x}Ru_x$ Composition

The magnetic properties of the $Co_{64}Cr_{22}Pt_{14}/Cr_{1-x}Ru_x$ films at different Ru concentrations are summarized in Table VIII. The effects of Ru concentration on the coercivity H_C and the coercivity squareness S^* of $Co_{64}Cr_{22}Pt_{14}/Cr_{1-x}Ru_x$ thin films are shown in Figure 23 and Figure 24.

The $Cr_{1-x}Ru_x$ layer with different compositions induced different in-plane H_C and S^* . The most interesting features in Figure 23 is that there is one valley at 43% Ru and two peaks at 24% and 57% Ru. The H_C at the valley was about 370 Oe. On the other hand, the H_C at 57% Ru reached as high as 4,100 Oe. The H_C of $Co_{64}Cr_{22}Pt_{14}/Cr_{1-x}Ru_x$ thin films was extremely sensitive to the concentration of Ru at the range between 25% Ru and 60% Ru. The sample with a composition of 57% Ru was most interesting. The H_C peak at 57% Ru was sharp. Within 2% Ru variation, the H_C varied by as much as 1,000 Oe.

The curve of S^* vs. Ru concentration shown in Figure 24 was similar to the curve of H_C vs. Ru concentration in Figure 23. The S^* at 27.3% Ru was highest, about 0.8, and the S^* at 57% Ru was about 0.7. When the Ru concentration was between 27.3% Ru and 57% Ru, the S^* dropped sharply and reached a valley of 0.036 at 43.4% Ru.

The H_C at 57% Ru was 4,100 Oe, which is much higher than the typical magnetic media of disk drive nowadays, 2,800 Oe. The S^* at 57% Ru was about 0.7, which is somewhat lower than the typical value of 0.8-0.9. From the values of H_C and S^* , 57% Ru is a potential underlayer material, but it might not have practical application because of the problem with reproducibility. Seven samples of 57% Ru were made. The variation of H_C and S^* were quite large because a small variation in Ru concentration caused a large change in H_C and S^* .

Co ₆₄ Cr ₂₂ Pt ₁₄ /Cr _{1-x} Ru _x /glass						
Sample #	Ru%	H _c (Oe)	S*	S	VMs (emu)	VMr (emu)
1	0.3	1745	0.5455	0.7335	0.00330	0.00242
2	6.2	1324	0.5030	0.6403	0.00341	0.00218
3	12.5	1691	0.5982	0.7006	0.00378	0.00265
4	18.7	2752	0.7661	0.7791	0.00355	0.00277
5	21.2	2582	0.7920	0.7708	0.00419	0.00323
6	24.0	2820	0.7916	0.7572	0.00401	0.00304
7	25.1	2594	0.7972	0.8040	0.00349	0.00280
8	27.3	2632	0.8159	0.7980	0.00371	0.00302
9	29.5	2393	0.4539	0.5438	0.00352	0.00191
10	30.6	1871	0.3005	0.3744	0.00338	0.00126
11	37.3	1086	0.2119	0.2682	0.00302	0.00081
12	43.4	368	0.0362	0.0373	0.00285	0.00011
13	47.5	390	0.0451	0.0477	0.00268	0.00013
14	53.3	1604	0.1775	0.2699	0.00176	0.00048
15	54.2	2350	0.5987	0.4838	0.00259	0.00126
16	55.1	2383	0.7865	0.7267	0.00312	0.00227
17	56.1	3377	0.6290	0.5690	0.00322	0.00183
18	56.1	3412	0.7550	0.7443	0.00281	0.00209
19	57.0	3012	0.6609	0.6675	0.00362	0.00241
20	57.0	3290	0.7062	0.6558	0.00333	0.00218
21	57.0	3753	0.6632	0.6488	0.00343	0.00223
22	57.0	3826	0.7075	0.6607	0.00301	0.00199
23	57.0	3945	0.5590	0.5734	0.00299	0.00171
24	57.0	4128	0.7390	0.8539	0.00267	0.00228
25	57.0	4213	0.6941	0.7205	0.00253	0.00182
26	58.2	3899	0.5190	0.5481	0.00288	0.00158
27	58.2	4095	0.7037	0.6578	0.00306	0.00201
28	59.4	3619	0.4816	0.5620	0.00319	0.00180
29	61.2	3019	0.4187	0.5098	0.00293	0.00150
30	63.9	2999	0.4011	0.4852	0.00302	0.00147
31	68.4	2987	0.3886	0.4824	0.00279	0.00135
32	72.9	2570	0.3200	0.3902	0.00311	0.00121
33	77.4	2673	0.3538	0.4342	0.00260	0.00113
34	79.2	2908	0.3789	0.4680	0.00258	0.00121
35	81.0	1580	0.3110	0.3830	0.00328	0.00129
36	84.1	1463	0.2067	0.3666	0.00360	0.00132
37	85.6	2595	0.3479	0.4395	0.00280	0.00123
38	86.4	2779	0.3595	0.4427	0.00261	0.00116
39	88.7	2677	0.3606	0.4359	0.00289	0.00126
40	91.7	2404	0.3726	0.4578	0.00318	0.00145
41	95.6	2822	0.4240	0.5139	0.00290	0.00149
42	99.7	3032	0.5657	0.6627	0.00308	0.00204

Table VIII. The experimental data from Phase I.

Figure 23. The in-plane coercivity of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{1-x}\text{Ru}_x$ vs. Ru concentration.

Figure 24. The coercivity squareness of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{1-x}\text{Ru}_x$ vs. Ru concentration.

4.5 Dependence of H_c and S^* on $Cr_{1-x}Ru_x$ Thickness and Substrate Temperature

Phase II of the experiment was to study the influence of $Cr_{1-x}Ru_x$ film thickness and substrate temperature on the coercivity at the fixed composition of $Cr_{43}Ru_{57}$. The thickness of $Cr_{1-x}Ru_x$ layer was varied from 50 Å to 1000 Å and the substrate temperature was varied from 25°C to 350°C. The experimental data from Phase II are shown in Table IX. The data are plotted in Figure 25.

Sample #	Deposition Temperature	$Cr_{1-x}Ru_x$ thickness	Coercivity H_c (Oe)	Coercivity Squareness
56	25°C	50 Å	1572	0.7598
57	25°C	100 Å	2133	0.4404
58	25°C	250 Å	2097	0.4031
59	25°C	500 Å	1909	0.3187
60	25°C	1000 Å	849	0.1157
62	100°C	50 Å	2707	0.7407
63	100°C	100 Å	3370	0.7953
64	100°C	250 Å	3628	0.7989
65	100°C	500 Å	4097	0.7918
66	100°C	1000 Å	3710	0.7819
68	250°C	50 Å	3154	0.5649
69	250°C	100 Å	4215	0.7197
70	250°C	250 Å	4182	0.7165
71	250°C	500 Å	4202	0.6980
72	250°C	1000 Å	3804	0.6068
74	350°C	250 Å	1519	0.2576
75	350°C	500 Å	2395	0.5109
76	350°C	1000 Å	2362	0.5438

Table IX. The experimental data from Phase II.

Figure 25. H_c as a function of the $\text{Cr}_{1-x}\text{Ru}_x$ layer thickness and substrate temperature.

With the same $\text{Cr}_{1-x}\text{Ru}_x$ thickness, the samples deposited at 100°C had larger coercivities than the samples deposited at 25°C. The samples deposited at 250°C had larger coercivities than the samples deposited at 100°C. But when the substrate temperature was increased to 350°C, the coercivities decreased. This is because the $\text{Cr}_{1-x}\text{Ru}_x$ film has a preferred deposition texture at different temperatures. From the X-ray diffraction spectra, the $\text{Cr}_{1-x}\text{Ru}_x$ film deposited at 250°C has more c-axis in-plane texture which induces more Co c-axis in-plane texture. Figure 26 shows the X-ray diffraction ratio of $\text{Co}(10\bar{1}0)$ and $\text{Co}(0002)$ vs. substrate temperature. Only the samples with 500 Å $\text{Cr}_{1-x}\text{Ru}_x$ film are shown. The 100°C and 250°C samples have stronger Co c-axis in-plane texture, and the higher H_c than the 25°C and 350°C samples.

Figure 26. The X-ray diffraction ratio of $Co(10\bar{1}0)$ and $Co(0002)$ vs. substrate temperature. All the samples have 500 Å $Cr_{1-x}Ru_x$ layers.

With the same substrate temperature, the coercivity increased between 50 Å and 100 Å. When the $Cr_{1-x}Ru_x$ thickness increased further, the coercivity reached a maximum, and then it starts to decrease slowly. The maximum H_C occurred around somewhere between 100 Å and 500 Å depending on the substrate temperature. At 50 Å, the film may be too thin and porous or the grain size too small to establish a good epitaxial relationship with the $Co_{64}Cr_{22}Pt_{14}$ layer. The H_C also decreased as the thickness of $Cr_{1-x}Ru_x$ layer increased to 1,000 Å. This may be due to the effect of the grain size. Larger $Cr_{1-x}Ru_x$ thickness will cause larger $Cr_{1-x}Ru_x$ grain size, and larger $Cr_{1-x}Ru_x$ grain size will induce larger $Co_{64}Cr_{22}Pt_{14}$ grain size which will decrease H_C .

Chapter 5

Discussion

5.1 The Structure of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ and $\text{Cr}_{1-x}\text{Ru}_x$ Thin Films

The structure of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ is HCP, Ru is HCP, and Cr is BCC. Figure 27 illustrates their structures and dimensions. The lattice parameter of Ru is slightly larger than the lattice parameter of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$. The good lattice matching between Ru lattice and $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ lattice make Ru a potential underlayer for $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ thin film.

$\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ has the same structure as Co, but a larger lattice parameter. The lattice parameters of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ were calculated from the X-ray diffraction spectra.

$\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ has larger lattice than Co because both Cr atom and Pt atom are larger than Co atom.

Figure 27. The structures and lattice parameters of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$, Ru and Cr.

Material	Co	Cr	Pt	Ru	Co ₆₄ Cr ₂₂ Pt ₁₄	Cr ₇₆ Ru ₂₄	Cr ₄₃ Ru ₅₇
Structure	HCP	BCC	FCC	HCP	HCP	BCC	HCP
Metallic Radius (Å)	1.25	1.30	1.39	1.34			
Lattice Parameters (Å)	a=2.507 c=4.070	a=2.885	a=3.924	a=2.706 c=4.282	a=2.580 c=4.188	a=2.906	a=2.695 c=4.264
Remark					Expanded Co structure	Expanded Cr structure	Compressed Ru structure

Table X. Structure, radius, and lattice parameters of Co, Cr, Pt, Ru, and their alloys.

Table X shows the structure type, atomic radius, and lattice parameters of Co, Cr, Pt, Ru, Co₆₄Cr₂₂Pt₁₄, Cr₇₆Ru₂₄, and Cr₄₃Ru₅₇. The data of the first four elements are from published data [47]. The data of the last three alloy materials are calculated from the X-ray diffraction data. From Table X, it is clear that large alloying elements will expand the structure, and small alloying elements will compress the structure.

From the experimental results, Cr_{1-x}Ru_x has Cr structure at 24% Ru, and becomes Cr₂Ru tetragonal structure at around 37% Ru. . Between 37% Ru and 53% Ru, Cr_{1-x}Ru_x is amorphous-like. When Ru concentration increases to 53% Ru or more, Cr_{1-x}Ru_x will transform to Ru structure

The experimental results are consistent with the Cr-Ru binary phase diagram, Figure 28. Comparing the experimental data with the Cr-Ru phase diagram, the phase found in the sputtered Cr_{1-x}Ru_x thin films have the structures which would form under equilibrium condition at 1,100°C, quenched to room temperature. Two compounds, Cr₃Ru and Cr₄Ru, found in the phase diagram at low temperature, were not found in the experiment. The film structure is equivalent to the structure at high temperature probably due to the energy transferred to the atoms during the sputtering process. The atoms possess some energy other than the thermal energy.

Figure 28. Cr-Ru phase diagram. The phase found in the sputtered $\text{Cr}_{1-x}\text{Ru}_x$ thin films have the structures which would form under equilibrium condition at 1,100°C (shown as horizontal dotted line), quenched to room temperature.

5.2 The Magnetic Anisotropy of Co alloy Thin Film

The magnetic properties of Co alloy thin film are anisotropic, i.e. the magnitude of magnetic property depends on the crystallographic orientation. The c-axis of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ is the magnetic easy axis. It takes less energy to magnetize and demagnetize along [0002] than along any other directions.

Figure 29 shows the M-H loops and the X-ray diffraction spectra of two samples. These two samples have the same thickness of both $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ and $\text{Cr}_{1-x}\text{Ru}_x$ layers. The only difference between these two samples is the Ru concentration of $\text{Cr}_{1-x}\text{Ru}_x$ layer. One sample has low H_C and low S^* , and the other has high H_C and high S^* . From the X-ray diffraction spectra, the sample with low H_C and low S^* has intense Co(0002) reflection line, indicating that the sample has strong Co(0002) parallel to the film plane texture. Most of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ grains have their magnetic easy axis, c-axis, normal to the film plane.

The other sample has high coercivity, high S^* , and less intense Co(0002) reflection line. Some of Co(0002) in-plane texture switches to Co($10\bar{1}0$) texture. Co($10\bar{1}0$) in-plane texture is c-axis in-plane texture. From the discussion above, to get more Co c-axis in-plane texture is one way to get high in-plane coercivity and high in-plane S^* . Using $\text{Cr}_{1-x}\text{Ru}_x$ underlayer is a method to control the orientation of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ layer.

Figure 28 proves that $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ has magnetic anisotropy. With more easy axis in-plane texture, the M-H loop is broader and more square. On the other hand, with more easy axis out-of-plane texture, the M-H loop is almost a straight line.

Figure 29. M-H loop comparison of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ with out-of-plane texture and $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ with in-plane texture. The left plots are the sample with low coercivity, low S^* , and strong Co(0002) diffraction line. The right plots are the sample with high coercivity, high S^* , and weak Co(0002) diffraction line. (Left: sample #13, right: sample #25)

5.3 The Epitaxy of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ Thin Film on $\text{Cr}_{1-x}\text{Ru}_x$ Underlayer

When $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ is deposited on $\text{Cr}_{1-x}\text{Ru}_x$, $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ grains will be oriented such that the strain energy is lowest. The crystallographic relations of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ grain with a Cr structure underlayer are well known. Literature Review 2.5.1 has covered this topic. In the amorphous region [24%-53% Ru], $\text{Cr}_{1-x}\text{Ru}_x$ film is like a glass substrate. The $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ layer develops a very strong c-axis out-of-plane texture when it deposits on the amorphous $\text{Cr}_{1-x}\text{Ru}_x$ layer. At 37.3% Ru, Cr_2Ru compound forms. $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ still has strong c-axis perpendicular to the plane texture when it is deposited on the Cr_2Ru compound. Cr_2Ru compound seems not a good underlayer to develop $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ c-axis in-plane texture. In the HCP region [53%-100% Ru], $\text{Cr}_{1-x}\text{Ru}_x$ structure and $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ structure are similar. They are both HCP structure and they have similar lattice parameters; therefore, $\text{Cr}_{1-x}\text{Ru}_x$ layer with a HCP structure is an effective underlayer for $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ layer.

Figure 30 shows four common crystallographic planes of HCP structure. If the shaded planes are parallel to the film plane, (0002) is c-axis out-of-plane texture, $(10\bar{1}0)$ and $(11\bar{2}0)$ are c-axis in-plane textures, and $(10\bar{1}1)$ is c-axis 29° to the plane texture. The X-ray diffraction shows that these four textures are most common in the experiment.

Figure 30. Four common crystallographic planes of HCP structure.

Figure 31. Plan view of (0002) and $(10\bar{1}0)$ of Co and Ru lattices.

Figure 31 shows the lattice match of Co and Ru lattices. The left diagram is a plan view of (0002) and the right diagram is a plan view of $(10\bar{1}0)$. The Ru atom is slightly larger than the Co atom, and the Ru lattice is also slightly larger than the Co lattice. The diagrams in Figure 31 are to scale. The lattice misfit between Co lattice and Ru lattice is small, around 2% depending on the Ru concentration.

The good lattice match of Co and Ru explains the phenomenon that the sample with strong Ru (0002) in-plane texture also have strong Co (0002) in-plane texture, and the sample with strong Ru $(10\bar{1}0)$ in-plane texture also has strong Co $(10\bar{1}0)$ in-plane, as shown in Figure 22. When the Ru concentration decreases, the Ru lattice shrinks, and the lattice misfit between Co and Ru structure decreases. Figure 32 shows the lattice misfit vs. Ru concentration. The lattice misfit is calculated from the X-ray diffraction data, which decreases as the Ru concentration decreases. The HCP Ru structure is destroyed when Ru concentration is lower than 53.3%. At 57% Ru, the sample has highest H_c and least lattice misfit. But the high H_c is probably due to the texture of $Cr_{1-x}Ru_x$ film, not due to the improvement of the lattice match.

Figure 32. The lattice misfit of Co[0002] and Ru[0002] vs. Ru concentration.

5.4 The Effects of the $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{1-x}\text{Ru}_x$ Crystallographic Texture on the In-plane Coercivity

Co c-axis is the magnetic easy axis. To increase the Co c-axis in-plane texture is one way to increase the in-plane H_C and S^* . But the crystallographic texture is not the only parameter determining the in-plane H_C and S^* . Average grain size, grain size distribution, stacking faults, and degree of crystalline perfection are all possible parameters affecting the magnetic properties.

Different variables have been investigated in the experiment, such as Ru concentration, underlayer thickness, and deposition temperature. The variables have different effects on the microstructure of $\text{Cr}_{1-x}\text{Ru}_x$ layer. The microstructure of $\text{Cr}_{1-x}\text{Ru}_x$ layer determines the microstructure of Co layer by epitaxy, and the microstructure of Co layer determines the magnetic property of the sample.

Figure 33 shows evidence that the more c-axis in-plane texture, the higher the coercivity. The samples in the diagram have the same $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ thickness. The X-ray intensity ratio of $\text{Co}(10\bar{1}0)/\text{Co}(0002)$ indicates the degree of Co in-plane texture. The in-plane coercivity has strong dependence on the ratio, at least up to 0.2.

Figure 33. In-plane coercivity vs. X-ray intensity ratio $\text{Co}(10\bar{1}0)/\text{Co}(0002)$.

Chapter 6

Conclusions

6.1 Summary and Conclusions

The magnetic properties of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{1-x}\text{Ru}_x$ thin films were studied in this thesis. $\text{Cr}_{1-x}\text{Ru}_x$ underlayers with a composition of 57% Ru deposited at 250°C induced strong c-axis in-plane $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}$ texture. The $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{1-x}\text{Ru}_x$ thin films at this sputtering condition had high in-plane H_C , around 4,100 Oe. Varying the $\text{Cr}_{1-x}\text{Ru}_x$ thickness and the deposition temperature further optimized the in-plane H_C to over 4,500 Oe. Unfortunately, the high H_C property only appeared within a very narrow Ru concentration around 57% Ru. The in-plane H_C dropped to around 3,000 Oe with Ru concentration increasing or decreasing only 2%.

The $\text{Cr}_{1-x}\text{Ru}_x$ thickness is an important parameter affecting the H_C of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{1-x}\text{Ru}_x$ thin films. The H_C increased when $\text{Cr}_{1-x}\text{Ru}_x$ thickness increased from 50 to 100 Å. Above 100 Å, H_C stopped increasing and then started decreasing gradually. The H_C dependence on the $\text{Cr}_{1-x}\text{Ru}_x$ thickness was due to the grain size. Large grain size caused H_C to decrease. Deposition temperature was another parameter affecting the H_C . The samples had highest H_C when deposited at 250°C. The samples lost their H_C and in-plane texture when they were deposited at room temperature or at 350°C. The $\text{Cr}_{1-x}\text{Ru}_x$ film had a preference to have $\text{Ru}(10\bar{1}0)$ in-plane texture when it was deposited at 250°C. The preferred texture induced Co c-axis in-plane texture and high in-plane H_C .

$\text{Cr}_{1-x}\text{Ru}_x$ may not be a practical underlayer material because of the following three problems. First, the H_C and S^* of $\text{Co}_{64}\text{Cr}_{22}\text{Pt}_{14}/\text{Cr}_{1-x}\text{Ru}_x$ are high at 57% Ru, but it appears only at a narrow Ru concentration region. That causes a problem to reproduce.

Second, Ru and most Ru compounds are toxic. The environmental and safety problem prevents Ru to be used for consumer products. Third, the high cost of Ru may limit its application. Even though, to expand the high H_c region around 57% Ru maybe worth investigating.

6.2 Suggestions for Future Study

There are many elements and alloys that could be a possible material for underlayer. There are also many sputtering parameters affecting the magnetic property of the samples. Some suggestions are given as follows for further underlayer material research.

1. Find a material such that the lattice of the material can match the lattice of Co structure in certain orientation. For example, find a HCP structure material with lattice parameters close to the lattice parameters of Co.
2. Select a element to alloy with the parent material. The minor element will change the lattice parameters of the structure and will improve the lattice matching with Co. The minor element may also change the property of the parent material, e.g., the preferred orientation when deposited. The minor element should not change the structure of the parent material. Check phase diagram that the parent element should have significant solubility of the minor element.
3. Try to optimize and expand the high H_c region by using different sputtering parameters, such as bias voltage, argon pressure, etc.
4. Use TEM to observe the microstructure of the films, such as grain size and stacking fault density.

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